

# BRIAN DAISAKU MCCLOSKEY MEMORIAL SCHOLARSHIP

#### About the Scholarship:

Brian was always learning...how things worked and how they could be made better. He did not color inside the lines, but found other ways of expressing himself. Brian was a friend to people of all backgrounds, without prejudice.

Before his passing, Brian had been planning an adventure across China and was learning Chinese in preparation for the trip. It was to be an off-road motorcycle trip that would take him along a journey of discovery, determination, struggle, transformation, and beauty. The beauty of the journey was that it represented the treasure which exists within all of us. It is the struggle to overcome personal hardships, to discover the strength within, and to use that internal fortitude to transform one's dreams into reality that makes the journey worthwhile.

Brian overcame great challenges in his life in order to make the impossible...possible.

To honor Brian and keep his memory alive, Guy and Doris McCloskey, along with their family and friends, have made a very generous scholarship available to admitted SUA students. To apply for the scholarship, please read Brian's experience at www.bdmsua.org/about-ba, and then complete this application.

#### **Scholarship Amount:**

The scholarship amount is determined at the completion of the 2020-21 academic year. Recipients will be notified by the Office of Financial Aid during the summer of 2021.

#### **Eligibility:**

The Brian Daisaku McCloskey Memorial Scholarship is available to undergraduate students currently enrolled in the 2020-21 academic year that will be returning in the 2021-22 academic year.

#### **Application Deadline:**

The deadline to submit your application to the Office of Financial Aid is May 31, 2021 by 5:00 PM PST.

SOKA UNIVERSITY OF AMERICA • OFFICE OF FINANCIAL AID • 1 UNIVERSITY DRIVE • ALISO VIEJO, CA • 92656 www.soka.edu/financialaid • financialaid@soka.edu • P: (949) 480-4342 • F: (949) 480-4151 Page 1 of 4

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## **Brian Daisaku McCloskey Memorial Scholarship**

(SCH)

2021-2022

## Office of Financial Aid

SECTION A: Student Information	
Name (Last, First, MI):	SUA Student ID#:
Current Grade Level:	Email:
SECTION B: Eligibility	
1.) Expected Graduation Date:	
2.) Cumulative GPA:	
<b>3.)</b> Have you completed a 2021-2022 Financial Aid Application?	YES NO
<b>4.)</b> You must attach an unofficial transcript to your application	
SECTION C: Certification (Check all boxes)	
Authorization – I authorize the Office of Financial Aid and/ status and any of the information provided as part of this s	
Release – If I am selected as a recipient of this scholarship, scholarship application and demographic information to the	•
Thank You Letter – If I am selected as a recipient of this so write a thank you letter to the donor prior to any scholarsh you letter will be delivered to the Office of Financial Aid. The delivering the thank you letter to the donor.	nip funds being awarded to my account. The thank

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## 2021-2022 Brian Daisaku McCloskey Memorial Scholarship

(SCH)

### Office of Financial Aid

SECTION D: Obstacle to Overcome
1.) In the space provided below, please describe an obstacle you have overcome or are working to overcome.
2.) List all significant awards, activities, leadership positions, service projects, and research projects that show how you
have overcome obstacles in your life:

(Please attach any supporting documentation that you believe would be relevant to this application.)

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### Office of Financial Aid

Student Name (print)

## 2021-2022 Brian Daisaku McCloskey Memorial Scholarship (SCH)

Date

**SECTION E: Impact of the Scholarship** 

	low, please explain how be ation and how it will help y			oskey Memorial Scholarsh
SECTION F: Signatu	ıre			
understand that any false state If selected for this scholarship,	hat all the information reported of ements or misrepresentation ma , it will be added to your financial nancial Aid if selected and will be	ay be cause for denial, re I aid package and may ir	duction, withdrawal, and/onpact eligibility for other fire	or repayment of this scholarship nancial aid awards. Recipients v

Applications and supporting documents can be mailed, mailed inter-office, hand-delivered, or emailed to the Office of Financial Aid at <a href="mailed-emailed

**Student Signature** 

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